

8-10-05

Handwritten signature/initials



EXPRESS MAIL NO.: EV 368015908 US
DATE DEPOSITED: August 8, 2005

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Pedretti, et al. Confirmation No.: 1009

Art Unit: 3729

Serial No.: 10/667,825

Examiner: Thiem D. Phan

Filed: September 22, 2003

Atty Dkt. No. 8245.060

For: Process for Manufacture of Printed Circuit Boards with Thick Copper Power Circuitry and Thin Power Signal Circuitry on the Same Layer

MAIL BOX FEE AMENDMENT
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT

Sir:

The following is submitted in response to the Office Action dated February 8, 2005.

Amendment to the Title begin on Page 2 of this paper.

Amendment to the Abstract begin on Page 3 of this paper.

Amendment to the claims begin on Page 4 of this paper.

Remarks begin on page 10 of this paper.